## **Michael Liang**

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EDUCATION	The University of Alger	y Almon Ohio			
EDUCATION	<ul><li>The University of Akron: Akron, Ohio</li><li>Bachelor of Science in Electronic and Electrical Engineering</li></ul>			Aug 2018 - Dec 2021	
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SKILLS	Rapid Prototyping	• KiCAD	• 3D Printing	<ul> <li>Hobby Machining</li> </ul>	
	<ul> <li>PCB Design</li> </ul>	<ul> <li>Soldering</li> </ul>	<ul> <li>Labview</li> </ul>	<ul> <li>Microcontrollers</li> </ul>	
	<ul> <li>SolidWorks</li> </ul>	• Laser Cutting	• MATLAB	C Programming	
WORK	Toast Inc : Boston, MA			Jun 2021 - August 2021	
EXPERIENCE	<ul> <li>Electrical Engineering Co-op</li> </ul>				
2111 211121 (02		• Fabricated a fully custom automated robotic hardware testing platform based on the ESP32 microcontroller.			
	<ul> <li>Worked closely with a cross disciplinary team of engineers to create detailed specifications for an upcoming tablet. Collaborated with ODM/JDM manufacturing vendors through out the product development lifecycle.</li> <li>Analyzed and reviewed designs with multiple high speed signals such as MIPI, LVDS, gigabit ethernet and USB C.</li> <li>Technologies Utilized: ESP32, Python, Fusion 360, RF Explorer, and PADs viewer.</li> <li>WardJET - Waterjet Cutting Machines : Tallmadge, Ohio</li> <li>May 2020 - May 2021</li> <li>Electrical Engineering Co-op</li> <li>Designed and implemented multiple data collection and analysis systems to assist with root cause analysis of clogs in cutting operations.</li> <li>Worked closely with engineers to develop processes for prototyping, testing and manufacturing of microphones and electronics for usage in waterjet process.</li> <li>Technologies Utilized: Python, Digital Signal Processing,Raspberry Pi, and MATLAB.</li> <li>University of Akron Undergraduate Research: Akron, Ohio</li> <li>Sep 2018 - March 2019</li> <li>Lab Assistant for LTA Research &amp; Exploration</li> <li>Worked closely with a multi-disciplinary team to develop custom rapid prototyping and fabrication solutions for a innovative Unmanned Aircraft System.</li> <li>Retrofitted new safety equipment, maintained, and calibrated a 300 watt industrial laser cutter.</li> <li>Maintained a print farm of over 15 industrial-grade 3d printers which ran 24/7.</li> <li>Technologies Utilized: SolidWorks 2018, Simplify3D, Octoprint, and RDWorks laser controller software.</li> <li>Summit County Engineer's Office: Akron, Ohio</li> <li>Engineering Intern</li> </ul>				
	<ul> <li>Assisted with drafting of plans in AutoCAD and learned industry standard engine</li> </ul>		-		
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PROJECTS					
	<ul> <li>Keyboard Warrior: A custom built STM32F303 keyboard running the QMK firmware.</li> <li>Goal: design and fabricate a modular mechanical keyboard with ability to extend functionality over i2c (number pad, OLED display, etc)</li> <li>Schematic and board routing was done in KiCAD. With attention paid to crystal oscillator design, USB differential pair layout, and power supply design.</li> <li>Mechanical design was done in SolidWorks. A custom stacked aluminum case design was chosen due to simplicity and</li> </ul>				
	ability to easily fabricate.				
	<ul> <li>LMS3990 CNC Conversion: A custom CNC Mill <ul> <li>A mini mill with a R8 spindle to CNC conversion with a 300mmx120mmx270mm build area.</li> <li>Electronics consist of Mach 3 breakout board, custom high current stepper drivers based on TMC5160 driver with encoder feedback, and a spindle speed controller.</li> <li>Mechanically designed in SolidWorks. Converted from linear lead screws to a C7 grade ball-screw system with custom made motor mounts.</li> </ul> </li> <li>HAkron Public Relations Officer: Akron's Official College Hackathon Group <ul> <li>Worked on expanding and engaging with engineering student organizations on campus in order to teach basic programming and electronics.</li> <li>Hosted HAkron 4K a hackathon which is a 24 hour invention marathon that encourages creativity, innovation, learning and engineering.</li> </ul> </li> </ul>				
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 Worked closely with a team to manage 80+ students and lead the electronics hardware team. Mentored several teams, organized access to the Bounce Innovation hub makerspace, and gained experience in teaching troubleshooting to non-technical individuals.